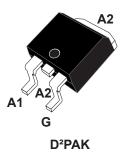
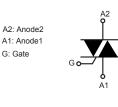




Datasheet

25 A - 800 V - T-series Triac in D²PAK







Product status link		
T2535T-8G		
Product summary		
I _{T(RMS)}	25 A	
V_{DRM}, V_{RRM}	800 V	
V_{DSM}, V_{RSM}	900 V	
I _{GT}	35 mA	

Features

- 25 A medium current Triac
- 150 °C maximum junction temperature T_J
- Surge capability V_{DSM}, V_{RSM} = 900 V
- Three triggering quadrants
- High noise immunity static dV/dt
- Robust dynamic turn-off commutation (dl/dt)c
- ECOPACK2 compliant component

Applications

- General purpose AC line load control
- AC induction and universal motor control
- Heating: water heater, e-bidet
- Power tools
- Cooker, oven
- Lighting and automation I/O control
- Inrush current limiting circuits
- Overvoltage crowbar protection

Description

The T2535T-8G Triac in SMD D²PAK package can be used for the on/off or phase angle control function in general purpose AC switching.

Based on the ST Snubberless technology, it offers higher specified turn-off commutation and noise immunity levels up to 150 °C.

SMD D²PAK package is suitable for automatic assembly line.

The T2535T-8G safely optimizes the control of the motors and heaters loads for the most constraining environments of home appliances.

1 Characteristics

Symbol	Parameter	Value	Unit		
I _{T(RMS)}	RMS on-state current (full sine wave) T _c = 121 °C			25	Α
L	Non repetitive surge peak on state surger (full surley T initial = 25 °C)		t = 16.7 ms	210	•
TSM	TSM Non repetitive surge peak on-state current (full cycle, T _j initial = 25 °C)			200	A
l ² t	I ² t value for fusing		t _p = 10 ms	264	A ² s
dl/dt	Critical rate of rise of on-state current, $I_G = 2 \times I_{GT}$, tr ≤ 100 ns, f = 100 Hz f = 120 Hz				A/µs
V _{DRM} /	Repetitive peak off-state voltage		T _j = 125 °C	800	
V _{RRM}			T _j = 150 °C	600	V
V _{DSM} / V _{RSM}	Non Repetitive peak off-state voltage t_p = 10 ms		T _j = 25 °C	900	V
I _{GM}	Peak gate current	t _p = 20 μs	T _j = 150 °C	4	Α
Р _{GM}	Maximum gate power dissipation $t_p = 20 \ \mu s$		T _j = 150 °C	5	W
P _{G(AV)}	Average gate power dissipation $T_j = 150 \text{ °C}$				W
T _{stg}	Storage temperature range				°C
Tj	Operating junction temperature range			-40 to +150	°C
TL	Maximum lead temperature for soldering during 10 s			260	°C

Table 1. Absolute maximum ratings (limiting values)

Table 2. Electrical characteristics (T_j = 25 °C, unless otherwise specified)

Symbol	Test conditions	Quadrants		Value	Unit
			Min.	5	mA
I _{GT}	V_D = 12 V, R_L = 30 Ω	1 - 11 - 111	Max.	35	- IIIA
V _{GT}					V
V _{GD}	$V_D = V_{DRM}$, $R_L = 3.3 \text{ k}\Omega$, $T_j = 150 \text{ °C}$	1 - 11 - 111	Min.	0.15	V
1.	$I_{G} = 1.2 \times I_{GT}$	1 - 111	Max.	50	mA
IL I		II	Max.	80	- IIIA
I _H ⁽¹⁾	I _T = 500 mA, gate open		Max.	35	mA
al) //alt (1)	V _D = 536 V, gate open	T _j = 125 °C	Min.	1500	V/µs
dV/dt ⁽¹⁾	V _D = 402 V, gate open	T _j = 150 °C	Min.	1000	V/µs
$(dl/dt) \circ (1)$	Without snubber network	T _j = 125 °C	Min.	28	A/ms
(dl/dt)c ⁽¹⁾		T _j = 150 °C	Min.	18	A/ms

1. For both polarities of A2 referenced to A1.

Table 3. Static characteristics

Symbol	bol Test conditions				Unit
V _{TM} ⁽¹⁾	I _{TM} = 35 A, t _p = 380 μs	T _j = 25 °C	Max.	1.5	V
V _{TO} ⁽¹⁾	Threshold voltage	T _j = 150 °C	Max.	0.80	V
R _D ⁽¹⁾	Dynamic resistance	T _j = 150 °C	Max.	17	mΩ
	V _D = V _R = 800 V, peak voltage	T _j = 25 °C		5	μA
1		T _j = 125 °C	5	mA	
I _{DRM} /I _{RRM}	$V_D = V_R = 600 V$, peak voltage	T _j = 150 °C	Max.	6	mA
	$V_D = V_R = 400 V$, peak voltage	T _j = 150 °C	Max.	5	ШA

1. For both polarities of A2 referenced to A1.

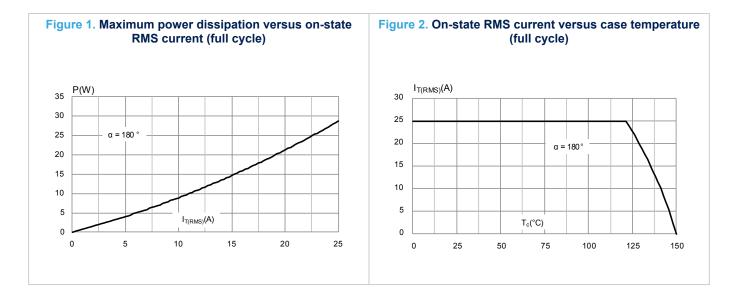
Table 4. Thermal resistance

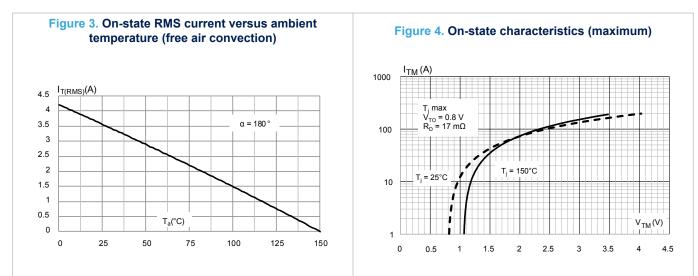
Symbol	Parameter		Value	Unit
R _{th(j-c)}	Junction to case (AC)	Max.	1	
R _{th(j-a)}	Junction to ambient (S _{CU} = 2 cm2)	Тур.	45	°C/W

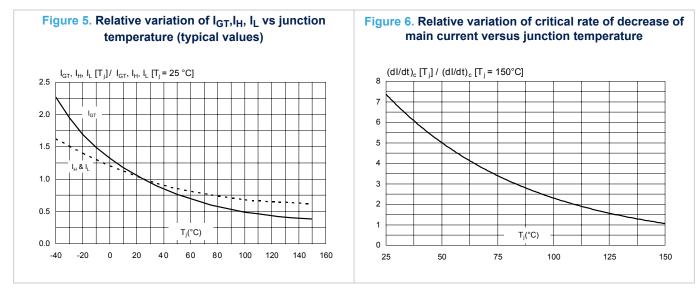
1. Scu : copper pad surface under tab, 35 µm copper thickness on FR4 PCB.

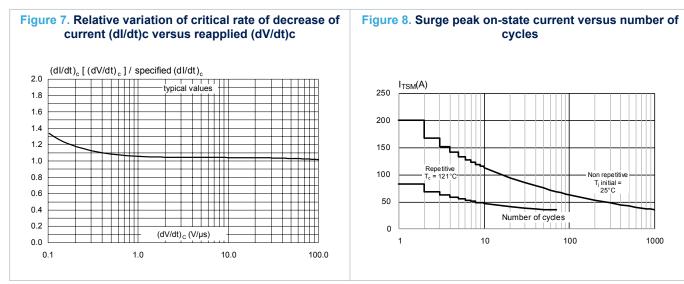


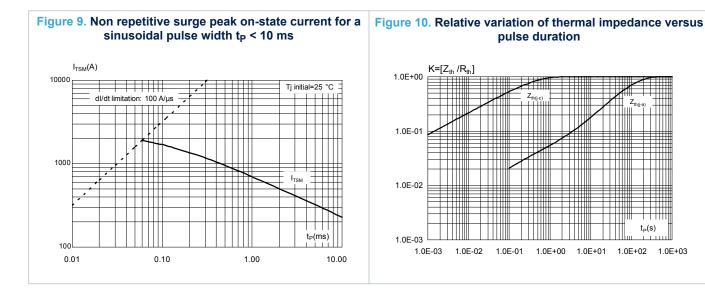
1.1 Characteristics (curves)













t_P(s)

1.0E+02 1.0E+03

1.0E+00

1.0E+01



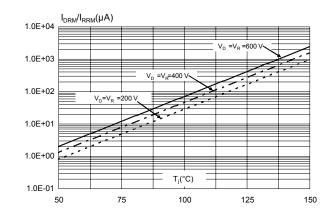


Figure 11. Leakage current versus junction temperature for different values of blocking voltage (typical values)

2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

2.1 D²PAK package information

- ECOPACK2 compliant
- Lead-free package leads finishing
- Molding compound resin is halogen-free and meets UL94 flammability standard level V0

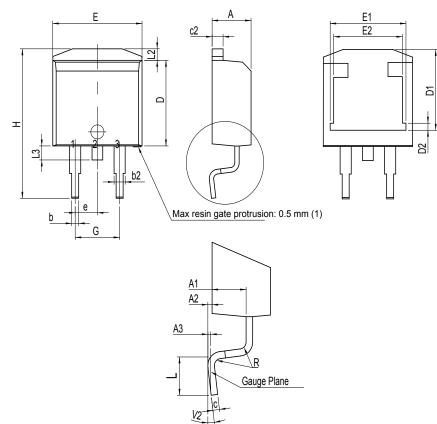


Figure 12. D²PAK package outline

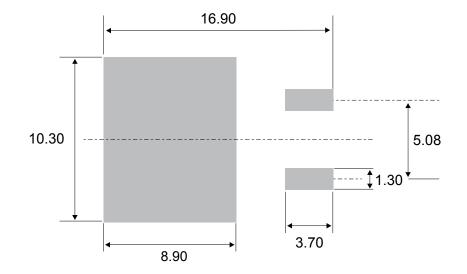
(1) Resin gate is accepted in each of position shown on the drawing, or their symmetrical.

Dimensions						
Ref.		Millimeters		Inches ⁽¹⁾		
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	4.30		4.60	0.1693		0.1811
A1	2.49		2.69	0.0980		0.1059
A2	0.03		0.23	0.0012		0.0091
A3		0.25			0.0098	
b	0.70		0.93	0.0276		0.0366
b2	1.25		1.7	0.0492		0.0669
С	0.45		0.60	0.0177		0.0236
c2	1.21		1.36	0.0476		0.0535
D	8.95		9.35	0.3524		0.3681
D1	7.50		8.00	0.2953		0.3150
D2	1.30		1.70	0.0512		0.0669
е	2.54			0.10000		
E	10.00		10.28	0.3937		0.4047
E1	8.30		8.70	0.3268		0.3425
E2	6.85		7.25	0.2697		0.2854
G	4.88		5.28	0.1921		0.2079
Н	15		15.85	0.5906		0.6240
L	1.78		2.28	0.0701		0.0898
L2	1.19		1.40	0.0460		0.0551
L3	1.40		1.75	0.0551		0.0689
R		0.40			0.0157	
V2 ⁽²⁾	0°		8°	0°		8°

Table 5. D²PAK package mechanical data

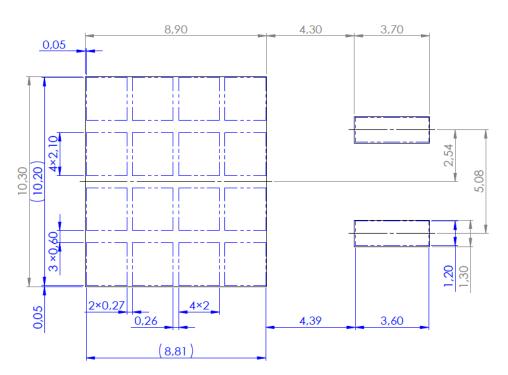
1. Dimensions in inches are given for reference only

2. Degrees



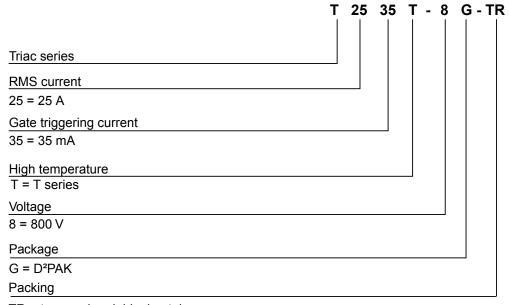






3 Ordering information

Figure 15. Ordering information scheme



TR = tape and reel, blank = tube

Table 6. Ordering information

Order code	Marking	Package	Weight	Base Qty.	Delivery mode	
T2535T-8G	T2535T-8G	D²PAK		160	50	Tube
T2535T-8G-TR	T2535T-8G		D²PAK 1.6 g	2500	Tape and reel	

Revision history

Table 7. Document revision history

Date	Version	Changes
23-Sep-2020	1	Initial release.



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